

# FGW35N60HD

**Discrete IGBT** 

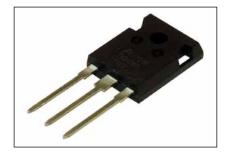
# Discrete IGBT (High-Speed V series) 600V / 35A

#### ■ Features

Low power loss Low switching surge and noise High reliability, high ruggedness (RBSOA, SCSOA etc.)

#### Applications

Uninterruptible power supply Power coditionner Power factor correction circuit

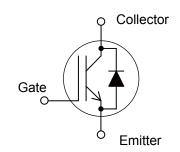


### **■** Equivalent circuit

# Maximum Ratings and Characteristics

# ● Absolute Maximum Ratings (at T<sub>c</sub>=25°C unless otherwise specified)

Items	Symbols	Characteristics	Units	Remarks
Collector-Emitter Voltage	Vces	600	V	
Gate-Emitter Voltage	V <sub>GES</sub>	±20	V	
DC Collector Current	Ic@25	64	Α	Tc=25°C,Tj=150°C
	Ic@100	35	Α	Tc=100°C,Tj=150°C
Pulsed Collector Current	Іср	105	Α	Note *1
Turn-Off Safe Operating Area	-	105	Α	Vce≤600V,Tj≤175°C
Diode Forward Current	F@25	30	Α	
	F@100	15	Α	
Diode Pulsed Current	I <sub>FP</sub>	105	Α	Note *1
Short Circuit Withstand Time	tsc	5	μs	Vcc≤300V,VgE=12V Ti≤150°C
IGBT Max. Power Dissipation	P <sub>D_IGBT</sub>	230	۱۸/	Tc=25°C
FWD Max. Power Dissipation	P <sub>D_FWD</sub>	80	W	Tc=25°C
<b>Operating Junction Temperature</b>	Tj	-40 ~ +175	°C	
Storage Temperature	T <sub>stg</sub>	-55 ~ +175	°C	



Note \*1 : Pulse width limited by Tjmax.

● Electrical characteristics (at T<sub>i</sub>= 25°C unless otherwise specified)

Items	Cumbala	Symbols Conditions		Characteristics		
items	Symbols	Conditions	min.	typ.	max.	Units
Collector-Emitter Breakdown Voltage	V <sub>(BR)CES</sub>	$I_{C} = 250 \mu A, V_{GE} = 0 V$	600	-	-	V
Zero Gate Voltage Collector Current	Ices	$V_{CE} = 600V$ , $V_{GE} = 0V$ $T_{j} = 25^{\circ}C$	-	-	250	μA
	IGES	I <sub>j</sub> =1/5°C	-	-	10	mA
Gate-Emitter Leakage Current	IGES	$V_{CE} = 0V$ , $V_{GE} = \pm 20V$	-	-	200	nA
Gate-Emitter Threshold Voltage	V <sub>GE (th)</sub>	V <sub>CE</sub> = +20V, I <sub>C</sub> = 35mA	4.0	5.0	6.0	V
Collector-Emitter Saturation Voltage	V <sub>CE</sub> (sat)	$V_{GE}$ = +15V, $I_{C}$ = 35A $T_{I}$ =25°C $T_{I}$ =175°C	-	1.50 1.80	1.95	V
Input Capacitance	Cies	V <sub>CE</sub> =25V	-	2800	-	
Output Capacitance	Coes	V <sub>GE</sub> =0V	_	140	-	pF
Reverse Transfer Capacitance	Cres	f=1MHz	-	100	-	"
		Vcc = 400V				
Gate Charge	Q <sub>G</sub>	Ic = 35A	-	210	-	nC
•		V <sub>GE</sub> = 15V				
Turn-On Delay Time	t <sub>d(on)</sub>	T <sub>j</sub> = 25°C	-	32	-	
Rise Time	t	Vcc = 400V	-	60	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	Ic = 35A	-	200	-	
Fall Time	tr	V <sub>GE</sub> = 15V	-	40	-	
Turn-On Energy	Eon	$R_G = 10\Omega$	-	0.90	-	
		L = 500µH				mJ
Turn-Off Energy	Eoff	Energy loss include "tail" and FWD reverse	-	0.85	-	1110
		recovery.				
Turn-On Delay Time	t <sub>d(on)</sub>	T <sub>j</sub> = 175°C	-	33	-	
Rise Time	t	Vcc = 400V	-	60	-	ns
Turn-Off Delay Time	t <sub>d(off)</sub>	Ic = 35A	-	225	-	
Fall Time	tr	V <sub>GE</sub> = 15V	-	50	-	
Turn-On Energy	Eon	$R_G = 10\Omega$	-	1.40	-	
Turn-Off Energy	Eoff	L = 500µH Energy loss include "tail" and FWD reverse	_	1.25	-	mJ
		recovery.				

http://www.fujielectric.com/products/semiconductor/

# ● FWD Characteristics

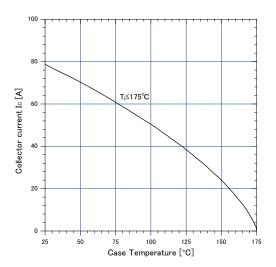
Description	Cumbal	Conditions	Conditions		Characteristics		
Description	Symbol	Conditions			typ.	max.	Unit
Forward Voltage Dren	VF	I=15A	T <sub>j</sub> =25°C	-	2.0	2.6	V
Forward Voltage Drop	VF	IF- IDA	T <sub>j</sub> =175°C	-	1.4	-	V
Diode Reverse Recovery Time	4	Vcc=30V,I <sub>F</sub> = 1.5A			24	31	ns
Didde Reverse Recovery Time	Trr1	-di/dt=200A/µs		-			
Diode Reverse Recovery Time	t <sub>rr2</sub>	Vcc=400V			0.03	_	μs
Diode Reverse Recovery Time	UTZ	I⊧=15A			0.00		μο
Diode Reverse Recovery Charge	Qrr	-di⊧/dt=200A/µs		_	0.06	_	μC
Blodd Noveled Neddvery Charge	Q.II	T <sub>j</sub> =25°C		0.00		μο	
Diode Reverse Recovery Time	t <sub>rr2</sub>	Vcc=400V		_	0.15	_	μs
	UIZ	I⊧=15A			0.10		μο
Diode Reverse Recovery Charge	Qrr	-di⊧/dt=200A/μs		_	0.65	_	μC
	l Gair	T <sub>i</sub> =175°C		1	0.00	_	40

# ● Thermal resistance characteristics

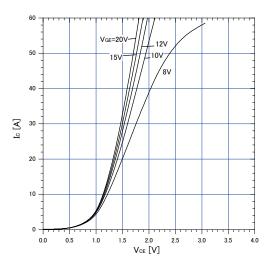
Items	Symbols	Conditions	Characteristics			Units
			min.	typ.	max.	Units
Thermal Resistance, Junction-Ambient	R <sub>th(j-a)</sub>	-	-	-	50	
Thermal Resistance, IGBT Junction to Case	R <sub>th(j-c)_IGBT</sub>	-	-	-	0.641	°C/W
Thermal Resistance, FWD Junction to Case	R <sub>th(j-c)_FWD</sub>	-	-	-	1.786	

# **■** Characteristics (Representative)

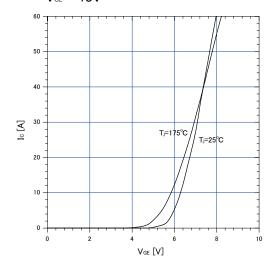
Graph.1 DC Collector Current vs  $T_c$   $V_{ce} \ge +15V$ ,  $T_i \le 175$ °C



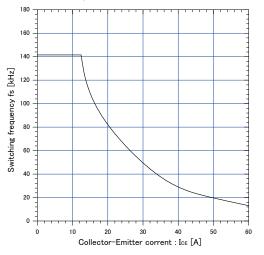
Graph.3
Typical Output Characteristics (V<sub>c∈</sub>-I<sub>c</sub>)
T,=25°C



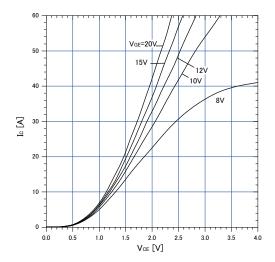
Graph.5 Typical Transfer Characteristics  $V_{\text{GE}}$ =+15V



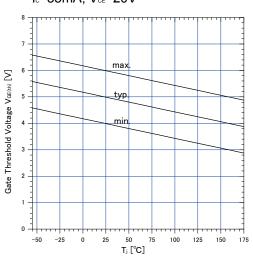
Graph.2 Collector Current vs. switching frequency  $V_{\text{ce}}$ =+15V,  $T_{\text{c}}$ ≤175°C,  $V_{\text{cc}}$ =400V, D=0.5,  $R_{\text{e}}$ =10 $\Omega$ ,  $T_{\text{c}}$ =100°C



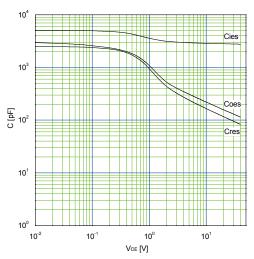
Graph.4
Typical Output Characteristics (V<sub>c∈</sub>-I<sub>c</sub>)
T<sub>i</sub>=175°C



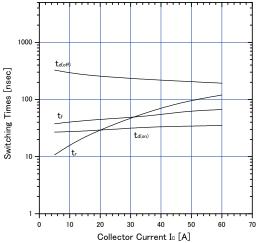
Graph.6
Gate Threshold Voltage vs. T<sub>i</sub>
I<sub>c</sub>=35mA, V<sub>cε</sub>=20V



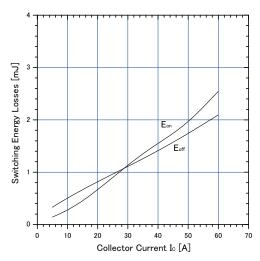
Graph.7 Typical Capacitance V₀=0V,f=1MHz,T,=25°C



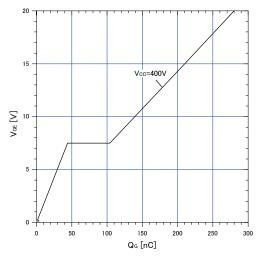
Graph.9 Typical switching time vs.  $I_c$  T<sub>i</sub>=175°C,V<sub>cc</sub>=400V,L=500 $\mu$ H V<sub>cε</sub>=15V,R<sub>c</sub>=10 $\Omega$ 



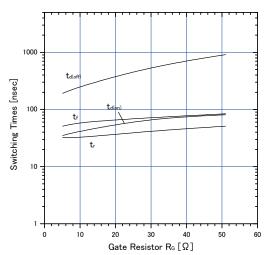
Graph.11 Typical switching losses vs. Io  $T_{\rm J}$ =175°C, $V_{\rm cc}$ =400V,L=500 $\mu$ H  $V_{\rm ce}$ =15V, $R_{\rm c}$ =10 $\Omega$ 



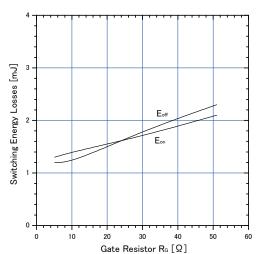
Graph.8 Typical Gate Charge Vcc=400V,Ic=35A,T;=25°C



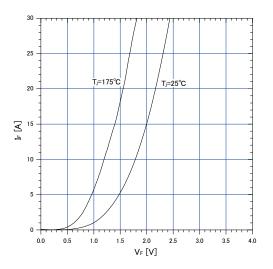
Graph.10 Typical switching time vs.  $R_{\rm G}$  T<sub>J</sub>=175°C,V<sub>CC</sub>=400V,I<sub>C</sub>=35A,L=500 $\mu$ H V<sub>GE</sub>=15V



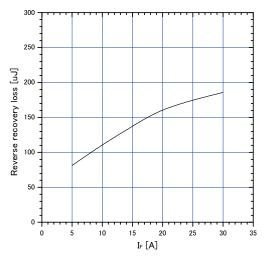
Graph.12 Typical switching losses vs.  $R_{\rm s}$  T<sub>J</sub>=175°C,V<sub>cc</sub>=400V,I<sub>c</sub>=35A,L=500 $\mu$ H V<sub>se</sub>=15V



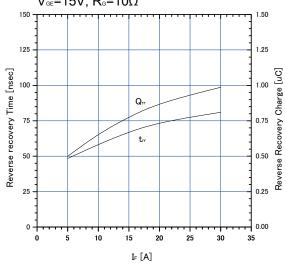
Graph.13 FWD Forward voltage drop  $(V_F-I_F)$ 



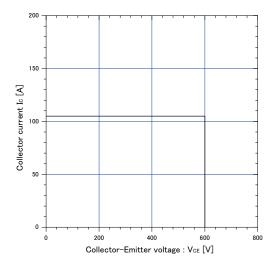
Graph.15 Typical reverse recovery loss vs.  $I_F$  $T_J$ =175°C,  $V_{cc}$ =400V, L=500 $\mu$ H  $V_{ce}$ =15V,  $R_c$ =10 $\Omega$ 



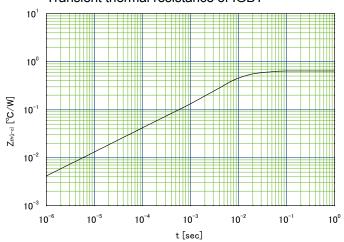
Graph.14 Typical reverse recovery characteristics vs.  $I_{\text{F}}$   $T_{\text{J}}$ =175°C,  $V_{\text{cc}}$ =400V, L=500 $\mu H$   $V_{\text{ce}}$ =15V,  $R_{\text{c}}$ =10 $\Omega$ 



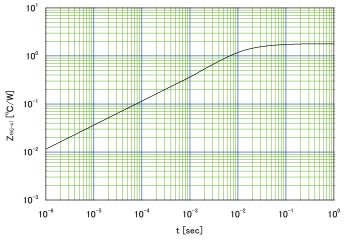
Graph.16 Reverse biased Safe Operating Area  $T_1 \le 175^{\circ}C$ ,  $V_{\text{GE}} = +15 \text{V/OV}$ ,  $R_{\text{G}} = 10 \Omega$ 



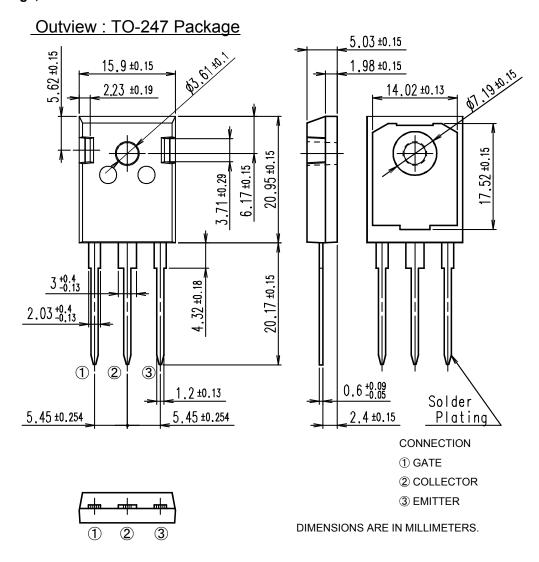
Graph.17 Transient thermal resistance of IGBT



Graph.18
Transient thermal resistance of FWD



# ■ Outline Drawings, mm



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